



Product Description

GRF4003 is a broadband low noise gain block designed for small cell, wireless infrastructure and other high performance applications. It exhibits outstanding broadband NF, linearity and return losses over 100 to 3800 MHz with a single match.

Configured as a first stage LNA, linear driver or cascaded gain block, GRF4003 offers high levels of reuse both within a design and across platforms. The device is operated from a supply voltage (VDD) of 1.8 to 5.5 V with a selectable I_{DDQ} range of 30 to 120 mA for optimal efficiency and linearity.

GRF4003 is internally matched to 50 Ω at the input and output ports, needing only external DC blocks and a bias choke on the output.

Consult with the GRF applications engineering team for custom tuning/evaluation board data and device s-parameters.

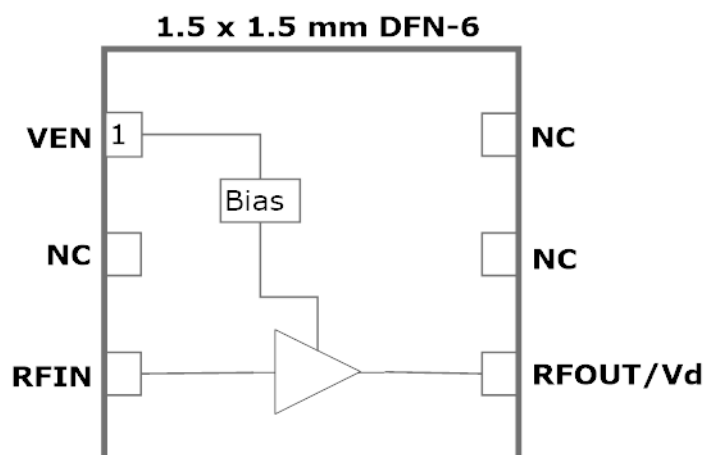
Features

Reference: 5V/95mA/2.5 GHz

- EVB NF: 0.85 dB
- Gain: 12.5 dB
- OP1dB: 25.0 dBm
- OIP3: 41.0 dBm
- Flexible Bias Voltage and Current
- Internally Matched to 50 Ω
- Process: GaAs pHEMT

Applications

- Linear Driver Amplifier
- Small Cells and Cellular Repeaters
- Distributed Antenna Systems
- First Stage LNA
- Microwave Backhaul



Absolute Ratings:

Parameter	Symbol	Min.	Max.	Unit
Supply Voltage	V _{DD}	0	6.0	V
RF Input Power: (Load VSWR < 2:1; V _D : 5.0 volts)	P _{IN MAX}		22	dBm
Operating Temperature (Package Heat Sink)	T _{AMB}	-40	105	°C
Maximum Channel Temperature (MTF > 10 ⁶ Hours)	T _{MAX}		170	°C
Maximum Dissipated Power	P _{DISS MAX}		700	mW
Electrostatic Discharge:				
Charged Device Model:	CDM	1500		V
Human Body Model:	HBM	250		V
Storage:				
Storage Temperature	T _{STG}	-65	150	°C
Moisture Sensitivity Level	MSL		1	--



Caution! ESD Sensitive Device



Exceeding Absolute Maximum Rating conditions may cause permanent damage to the device.

Note: For manufacturing information, see the Guerrilla-RF.com website for the following document located on the GRF4003 landing page: **Manufacturing Note—MN-001 Product Tape and Reel, Solderability and Package Outline Specification.**

[Link to manufacturing note](#)

Pin Out (Top View)



Pin Assignments:

Pin	Name	Description	Note
1	V _{ENABLE}	Enable Voltage Input	V _{ENABLE} and series resistor set I _{DDQ} . V _{ENABLE} < 0.2 volts disables device. On-die pull-down resistor will turn the part off if this node is allowed to float.
2	NC	No Connect or Ground	No internal connection to die
3	RF_In	LNA RF input	Internally matched 50Ω. An external DC blocking cap must be used.
4	RF_Out	LNA RF output	Internally matched 50Ω. V _{DD} must be applied through a choke to this pin
5	NC	No Connect or Ground	No internal connection to die
6	NC	No Connect or Ground	No internal connection to die
PKG BASE	GND	Ground	Provides DC and RF ground for LNA, as well as thermal heat sink. Recommend multiple 8 mil vias beneath the package for optimal RF and thermal performance. Refer to evaluation board top layer graphic on schematic page.



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GRF4003

Broadband LNA/Linear Driver
0.1–3.8 GHz

Nominal Operating Parameters:

Parameter	Symbol	Specification			Unit	Condition
		Min.	Typ.	Max.		
Test Frequency	F _{TEST}		2500		MHz	V _{DD} = 5.0 V, T _A = 25 °C
Gain	S ₂₁	11.5	12.5		dB	
Evaluation Board Noise Figure	NF		0.85	1.05	dB	
Output 3rd Order Intercept	OIP ₃		41.0		dBm	+2.0 dBm P _{OUT} per tone at 2 MHz Spacing (2499 and 2501 MHz)
Output 1dB Compression Power	OP1dB	23.5	25.0		dBm	
Switching Rise Time	T _{RISE}		500		ns	
Switching Fall Time	T _{FALL}		500		ns	
Supply Current	I _{DD}	76.0	95.0	114.0	mA	Target I _{DDQ} : 95 mA
Enable Current	I _{ENABLE}		3.0	6.0	mA	
Disabled Mode						
Leakage Current	I _{LEAKAGE}		3	30	uA	V _{DD} : 5.0V; V _{ENABLE} : 0.0V
Thermal Data						
Thermal Resistance: (Infra-Red Scan)	Θ _{jc}		117		°C/W	On standard Evaluation Board
Channel Temperature @ +85 C Reference (Package heat sink)	T _{CHANNEL}		141 (See note)		°C	V _{DD} : 5.0 V; I _{DDQ} : 95 mA; No RF; P _{DISS} : 475 mW

Note: MTTF >10⁶ hours for T_{CHANNEL} <=170 degrees C.

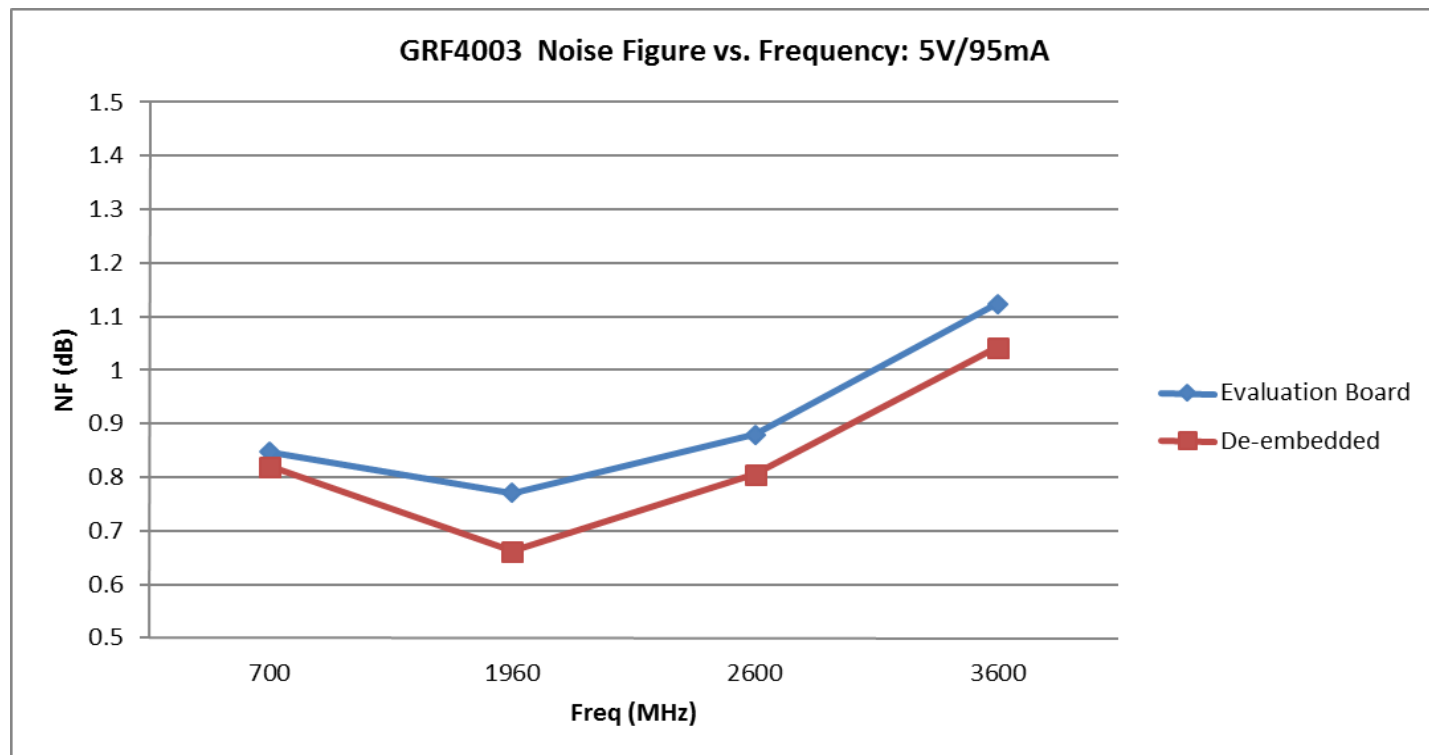
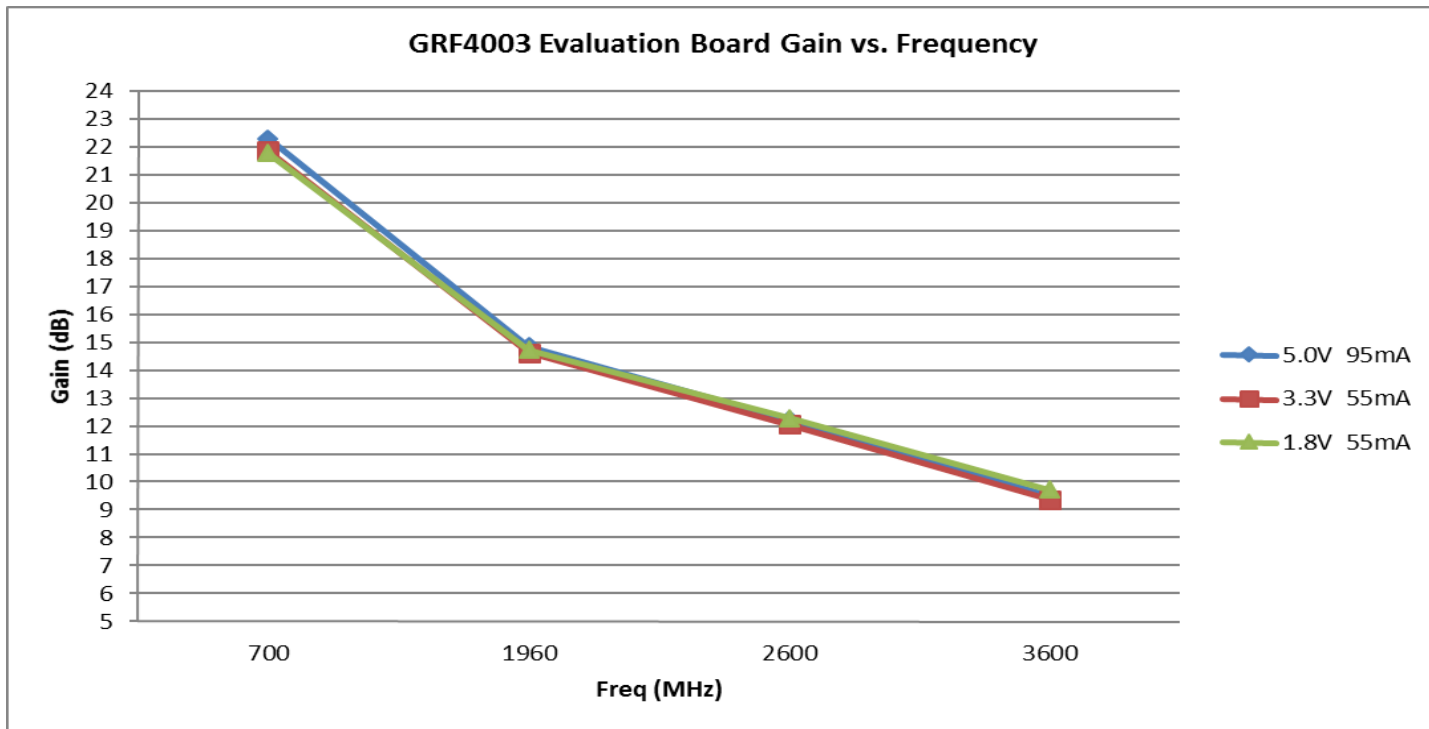


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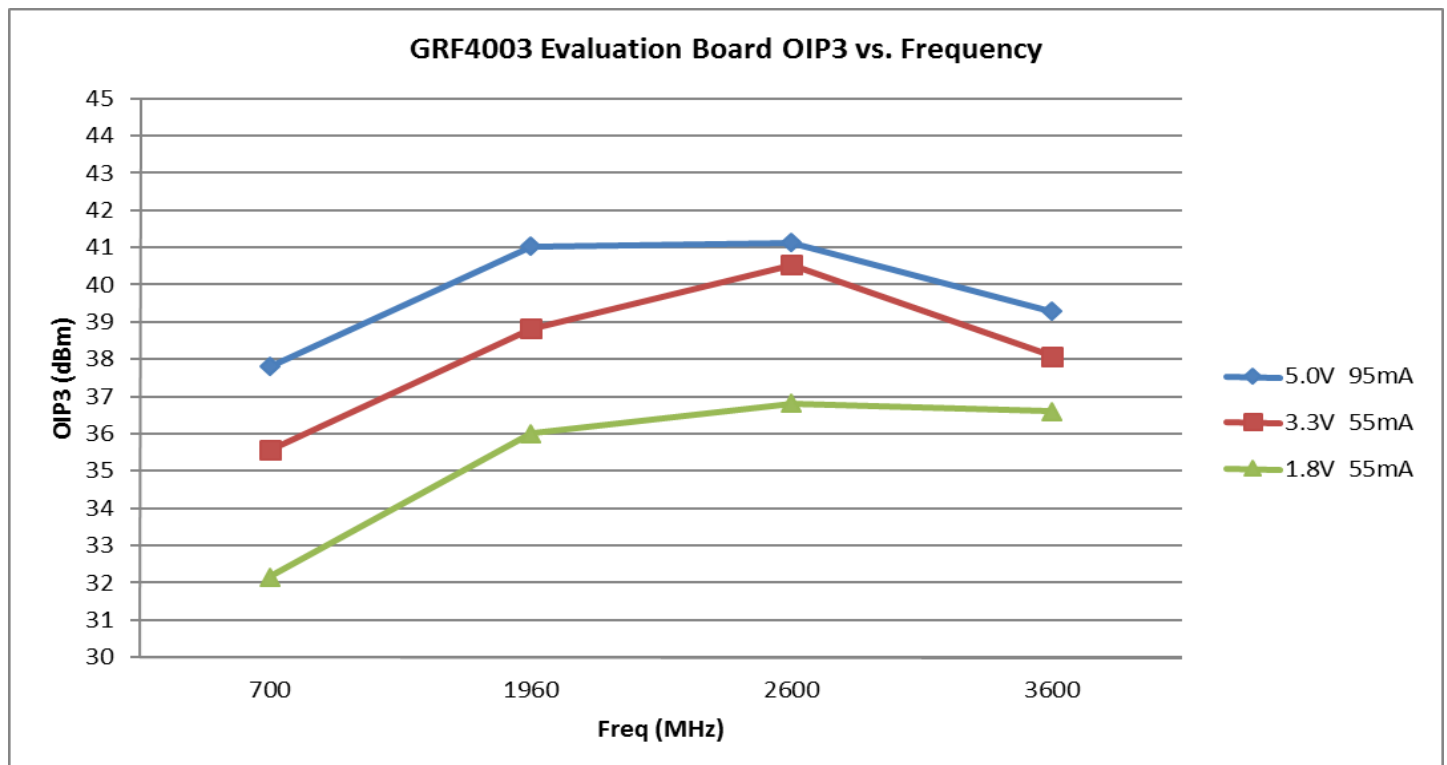
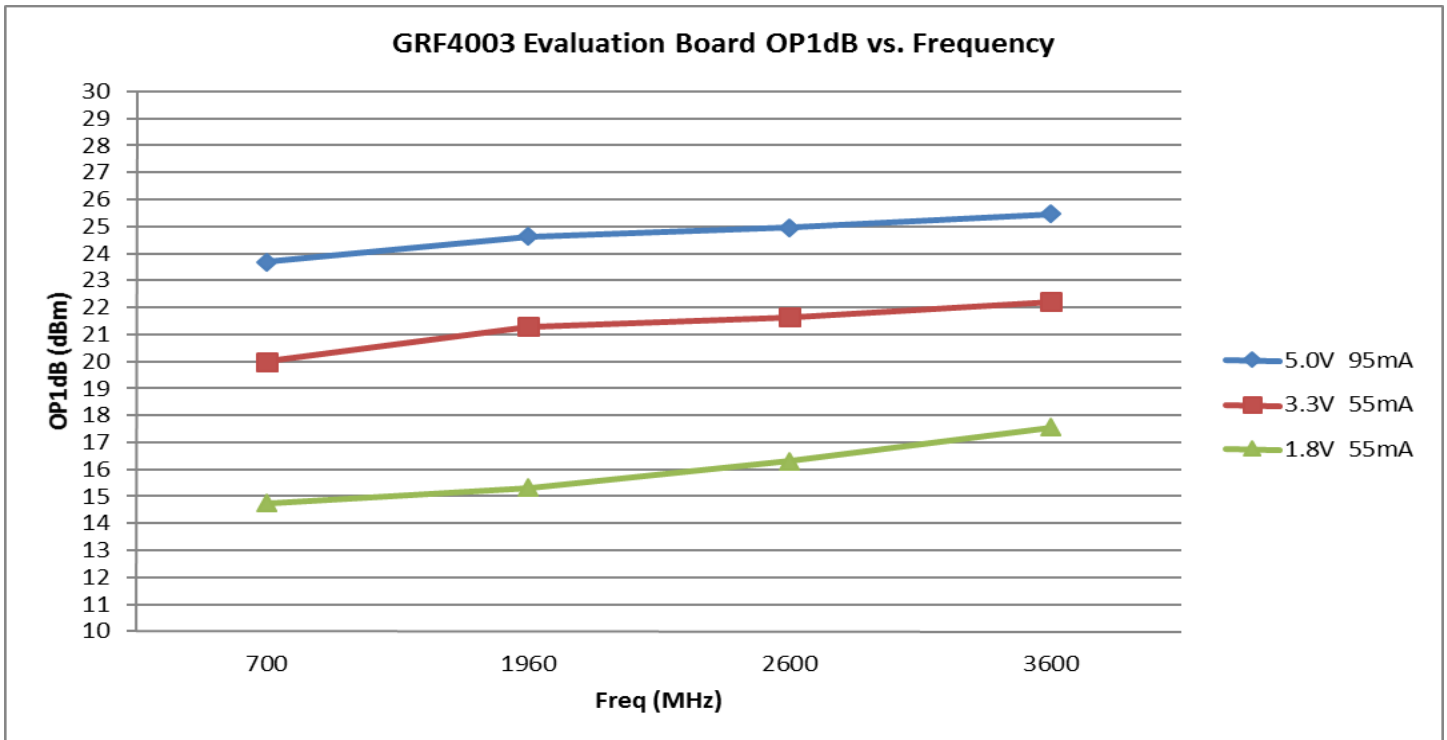
GRF4003

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GRF4003 Evaluation Board Measured Data:



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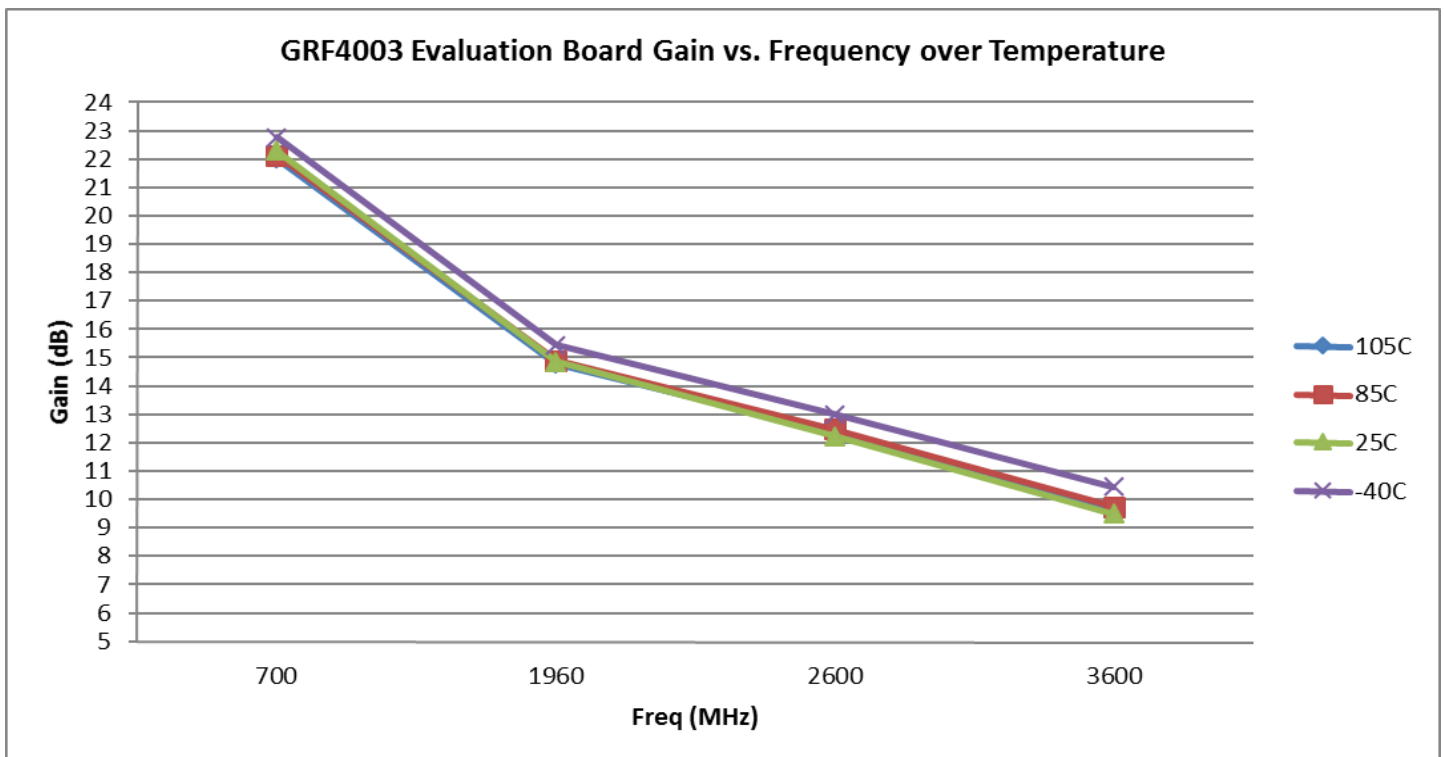
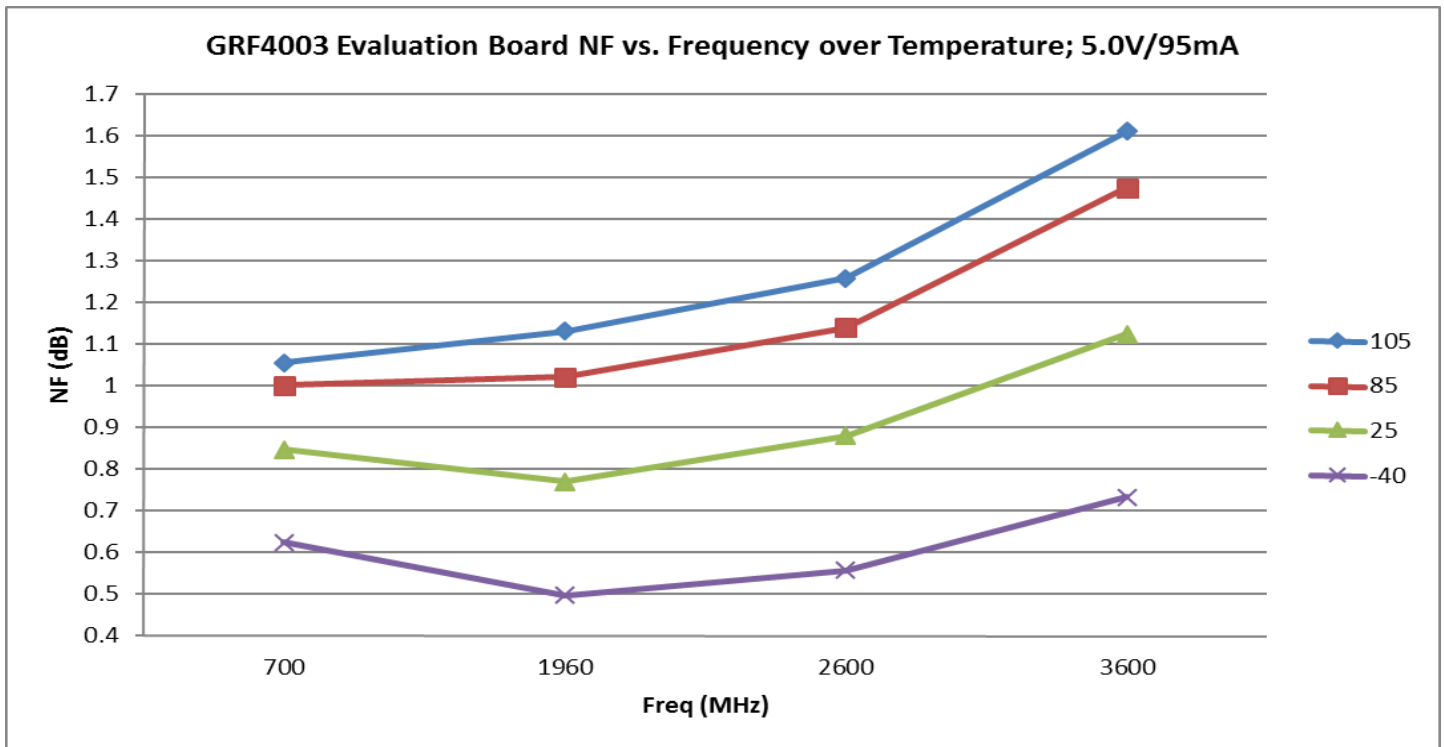


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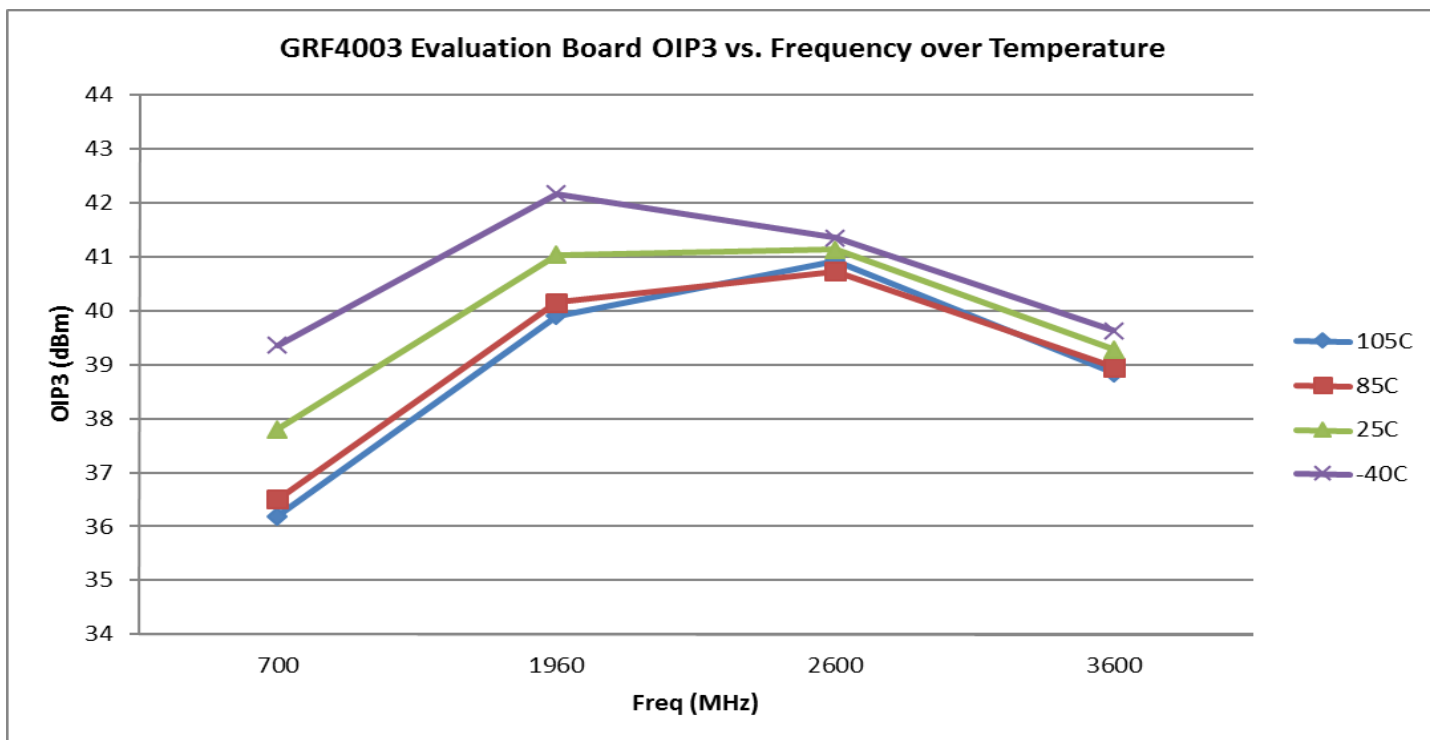
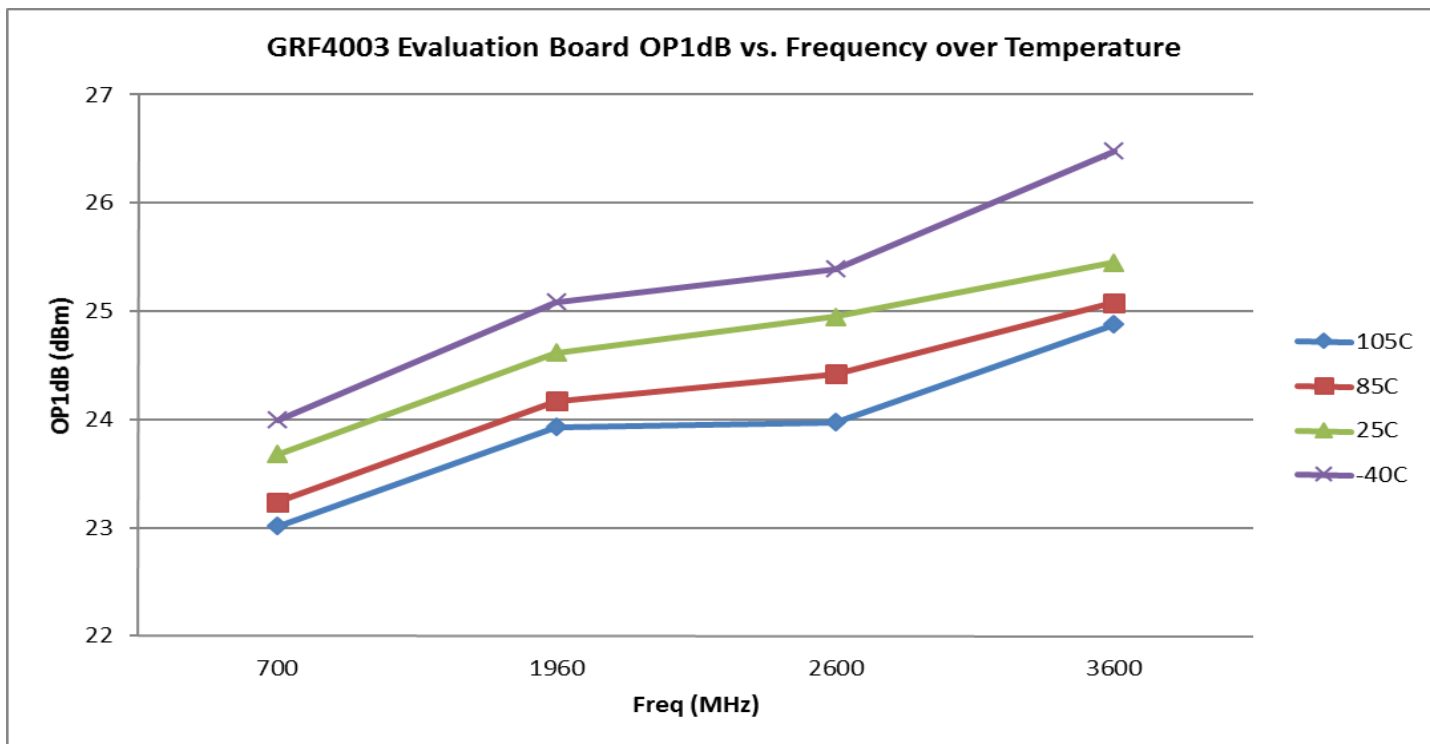
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GRF4003 Evaluation Board Performance over Temperature: (5V/95mA)



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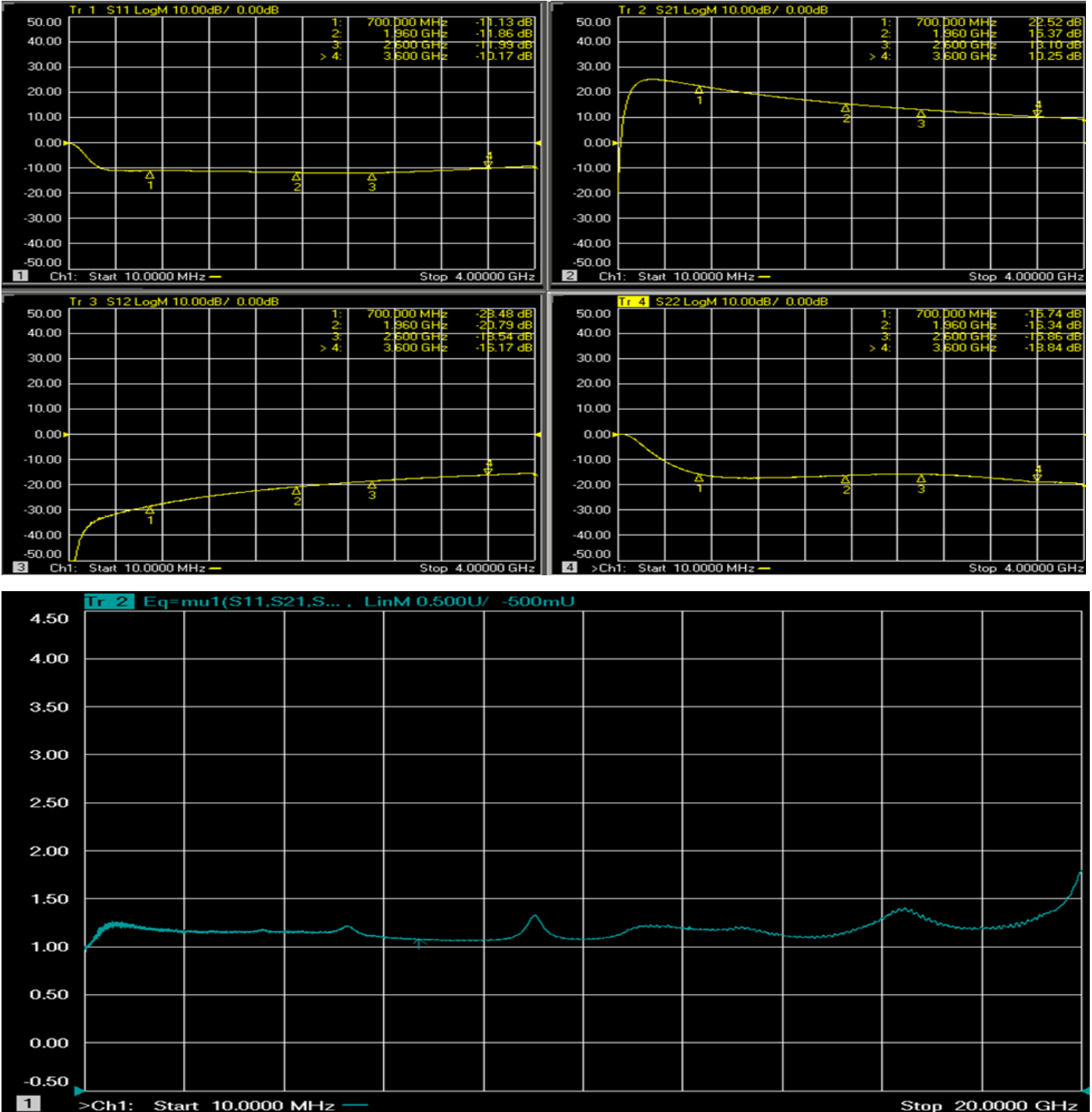


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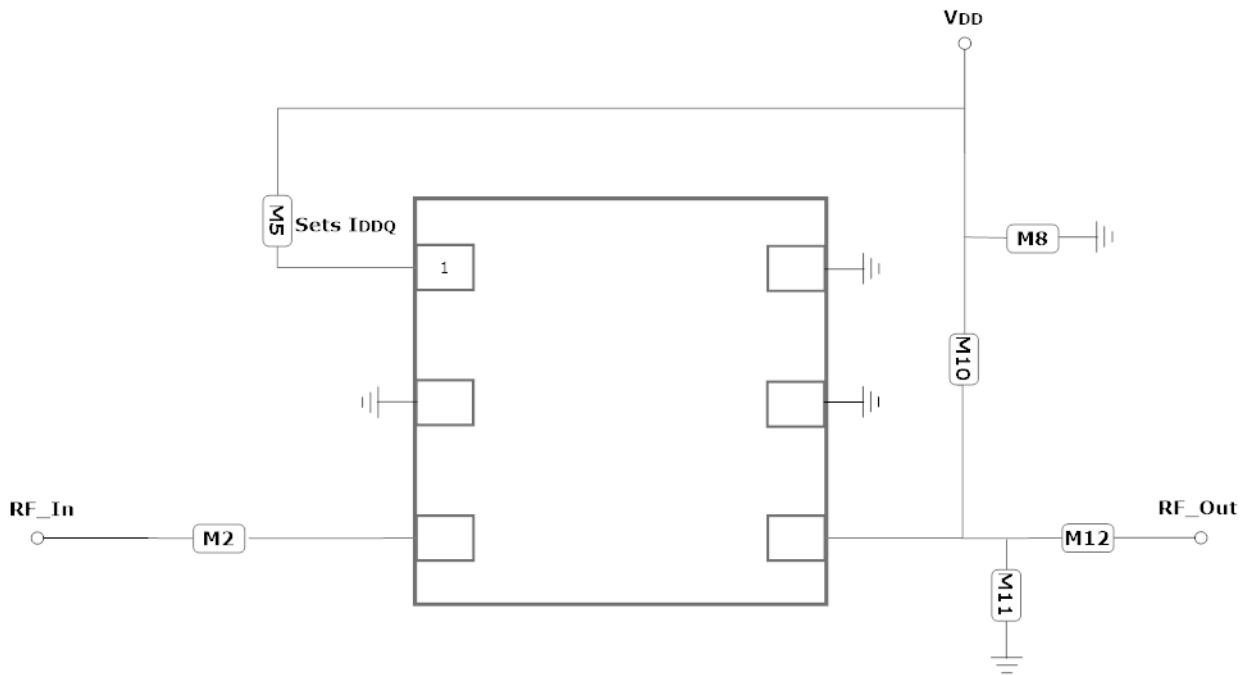
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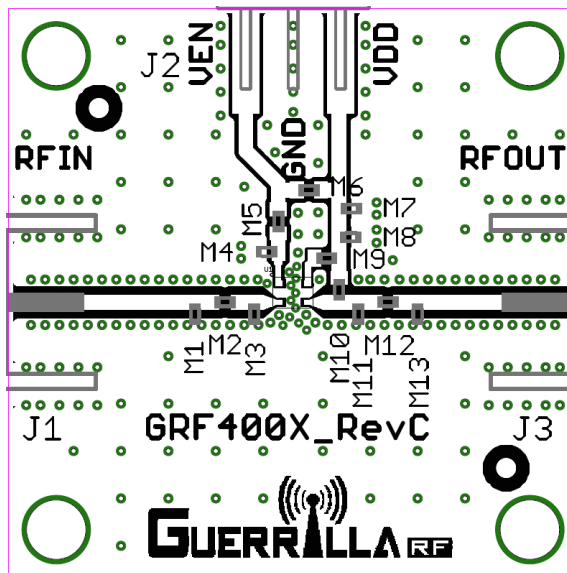
GRF4003 Evaluation Board S-Pars and Stability Mu Factor: (0.7 – 3.8 GHz Match)



Note: Mu factor ≥ 1.0 implies unconditional stability.



GRF4003 Application Schematic



GRF400X Evaluation Board Assembly Diagram



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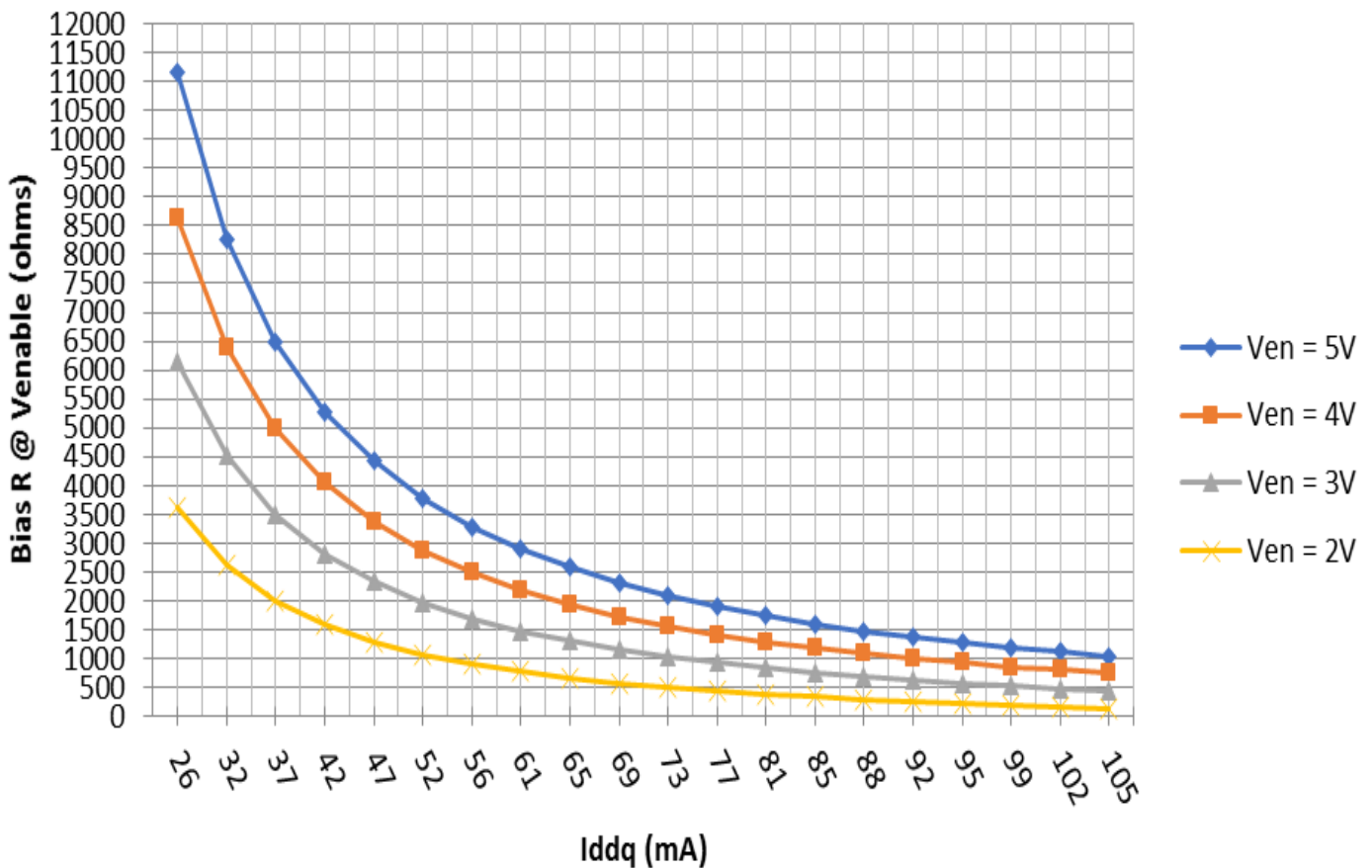
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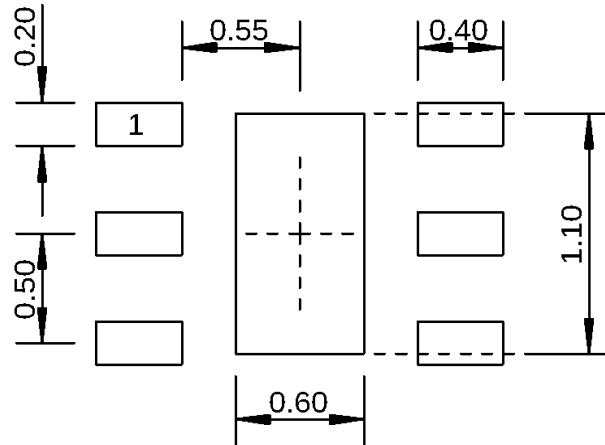
Broadband LNA/Linear Driver
0.1–3.8 GHz

GRF4003 Standard Evaluation Board BOM: (0.7 to 3.8 GHz Tune)

Component	Type	Manufacturer	Family	Value	Package Size	Substitution
M2	Capacitor	Murata	GJM	30 pF	0402	ok
M5 (See curves)	Resistor: 5%	Various	—	—	0402	ok
M8	Capacitor	Murata	GRM	0.1 uF	0402	ok
M10	Inductor	Murata	LQG	68 nH	0402	ok
M11	Capacitor	Murata	GJM	0.5 pF	0402	ok
M12	Capacitor	Murata	GJM	10 pF	0402	ok

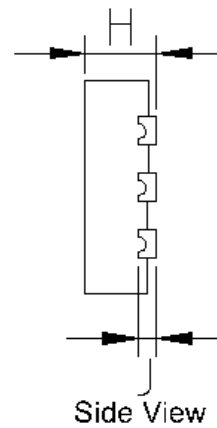
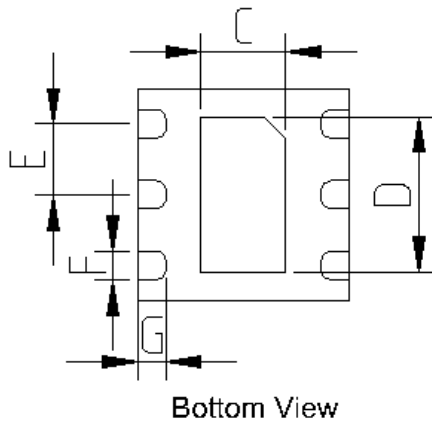
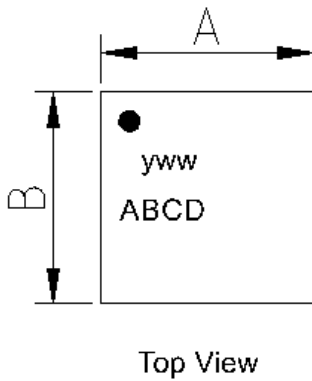
GRF4003 w/V_{dd} = 5.0V: Required Bias R @ Venable vs. I_{ddq}





Dimensions in millimeters

1.5 mm DFN-6 Suggested PCB Footprint (Top View)



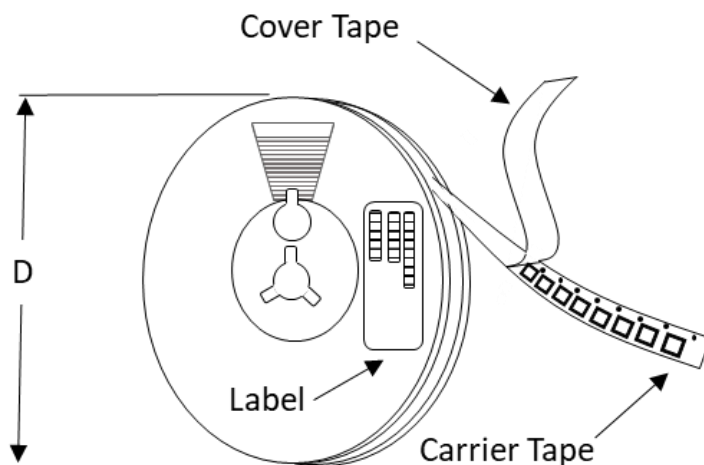
Dimensions (MM)	
A	1.5 +/- 0.050
B	1.5 +/- 0.050
C	.6 +/- 0.050
D	1.1 +/- 0.050
E	.5 Bsc
F	.2 +/- 0.050
G	.2 +/- 0.050
H	.45 +/- 0.050
J	.12 Ref.

1.5 mm DFN-6 Package Dimensions

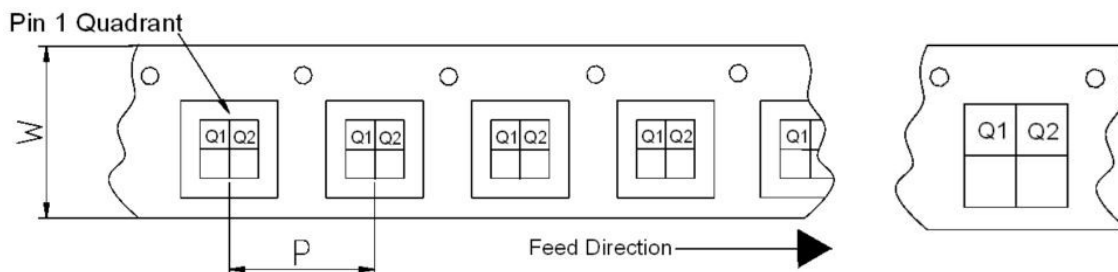
Tape and Reel Information:

Guerrilla RF’s Tape and Reel specification complies with the Electronics Industries Association (EIA) standards for ‘Embossed Carrier Tape of Surface Mount Components for Automatic Handling’. Reference EIA-481. See the table on the following page for Tape and Reel specifications along with units per reel.

Devices are loaded with pins down into the carrier pocket with protective cover tape, wound into a plastic reel. Each reel will be packaged in a cardboard box. There will be product labels on the reel, the protective ESD bag and the outside surface of the box.



Tape and Reel Packaging with Reel Diameter Noted (D)



Carrier Tape Width (W), Pitch (P), Feed Direction and Pin 1 Quadrant Information



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Tape and Reel Specification and Device Package Information Table

Package				Carrier Tape			Reel	
Type	Dimensions (mm)	Leads	Weight (mg)	Width (W) (mm)	Pocket Pitch (P) (mm)	Pin 1 Quadrant	Diameter (D) (inches)	Units per Reel
QFN	2.0 x 2.0 x 0.50	12	7	8	4	Q1	7	2500
QFN	3.0 x 3.0 x 0.85	16	24	12	8	Q1	7	1500
DFN	1.5 x 1.5 x 0.45	6	4	8	4	Q1	7	2500
DFN	2.0 x 2.0 x 0.75	8	12	8	4	Q1	7	2500
LFM	3.5 x 3.5 x 0.75	See note	TBD	12	8	Q2	7	1500
LFM	4.0 x 4.0 x 0.75	See note	TBD	12	8	Q2	7	1500

Note: Lead count may vary. Reference applicable product data sheet